





BY296-BY299

Vishay General Semiconductor

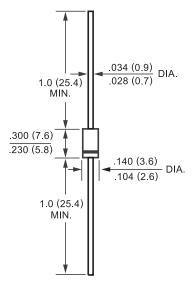
FEATURES

- Fast switching
- Low leakage
- Low forward voltage drop
- High current capability
- High current surge
- High reliability

MECHANICAL DATA

Case: Molded plastic Epoxy: UL 94V-0 rate flame retardant Lead: MIL-STD-202E, Method 208 guaranteed Mounting position: Any Weight: 0.38 gram

DO-15



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.

	SYMBOL	BY296	BY297	BY298	BY299	UNITS
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	100	200	400	800	Volts
Maximum RMS Voltage	V _{RMS}	70	140	280	560	Volts
Maximum DC Blocking Voltage	V _{DC}	100	200	400	800	Volts
Maximum Average Forward Rectified Current at TA = 75°C	Ι _ο	2.0				Amps
Peak Forward Surge Current 8.3 ms single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	70				Amps
Maximum Instantaneous Forward Voltage at 2.0A DC	V _F	1.3				Volts
Maximum DC Reverse Current at Rated DC Blocking Voltage TA = 25°C		5.0				uAmps
Maximum Full Load Reverse Current Full Cycle Average, .375*(9.5mm) lead length at T L = 55° C	- I _R	100				uAmps
Maximum Reverse Recovery Time (Note 1)	t _{rr}	150 5			500	nSec
Typical Junction Capacitance (Note 2)	CJ	40				pF
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to + 150				°C

NOTES: 1. Test Conditions: IF = 0.5A, IR = 1.0A, IRR = 0.25A

2. Measured at 1 MHZ and applied reverse voltage of 4.0 volts

50

40

100

100

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FIG. 2 - MAXIMUM NON-REPETITIVE FORWARD

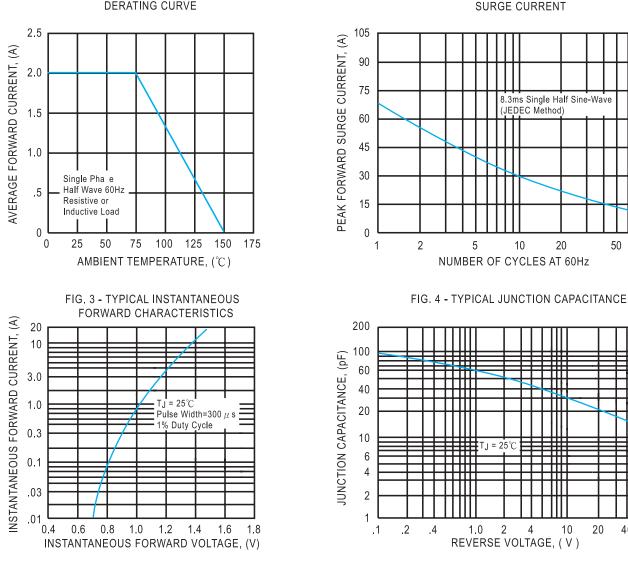


FIG. 1 - TYPICAL FORWARD CURRENT DERATING CURVE

FIG. 5 - TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTIC

